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FAXinterview_summary_Proposed_Amendment
6/11/2009

To:	Company	Fax #:	Telephone #:
1) Examiner Pham	USPTO	(571) 273-1696	
2)			
3)			
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From: Anthony J. Canning	Date: June 11, 2009	No. of Pages: 5 (including this page)	
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REVISED PROPOSED EXAMINER'S AMENDMENT

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Attorney Docket No. 740756-2948

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:)
Shinji MAEKAWA et al.) Group Art Unit: 2894
Application No. 10/574,616) Examiner: Thanhha S. Pham
Filed: April 5, 2006) Confirmation No. 2107
For: METHOD FOR FORMING PATTERN, THIN)
FILM TRANSISTOR, DISPLAY DEVICE AND) Date: **DRAFT**
METHOD FOR MANUFACTURING THE SAME,)
AND TELEVISION DEVICE)

REVISED PROPOSED EXAMINER'S AMENDMENT OF THE CLAIMS -NOT FOR ENTRY

Applicants respectfully request that the following amendments to the claims be included in an Examiner's Amendment. Examiner Pham proposed the following amendment to the claims, stating that such an amendment would place the claims in condition for allowance.

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IN THE CLAIMS:

This listing of claims will replace all prior versions, and listings, of claims in the application:

1. (Currently Amended) A method for forming a pattern comprising the steps of: forming a wiring of a semiconductor device over a light-transmitting substrate; forming a first region having a substance including a light-absorbing material over the light-transmitting substrate and the wiring;

forming a second region by irradiating the substance with light to modify a part of a surface of the substance wherein the light has a wavelength which is absorbable by the light-absorbing material; and

forming a conductive pattern on the part of the surface of the substance on the second region by discharging a compound including a pattern forming material,

wherein the part of the surface of the substance is modified so that the second region has a higher wettability than the first region with respect to the compound.

2. (Currently Amended) A method for forming a pattern comprising the steps of: forming a wiring of a semiconductor device over a light-transmitting substrate; forming a first region having a substance including a light-absorbing material over the light-transmitting substrate and the wiring;

forming a second region by irradiating the substance with light through the light-transmitting substrate to modify a part of a surface of the substance wherein the light has a wavelength which is absorbable by the light-absorbing material; and

forming a conductive pattern on the part of the surface of the substance on the second region by discharging a compound including a pattern forming material,

wherein the part of the surface of the substance is modified so that the second region has a higher wettability than the first region with respect to the compound.

3. (Currently Amended) A method for forming a pattern comprising the steps of:

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forming a wiring of a semiconductor device over a light-transmitting substrate;
forming a first region having a substance including a light-absorbing material over the light-transmitting substrate and the wiring;

forming a second region by irradiating the substance with a light through the light-transmitting substrate to modify a part of a surface of the substance wherein the light has a wavelength which is absorbable by the light-absorbing material;

removing the light-absorbing material; and

forming a conductive pattern on the part of the surface of the substance on the second region by discharging a compound including a pattern forming material,

wherein the part of the surface of the substance is modified so that the second region has a higher wettability than the first region with respect to the compound.

4. (Previously Presented) The method for forming a pattern according to any one of claims 1, 2 and 3, wherein the light-absorbing material is dissolved in the substance to form the substance including the light-absorbing material.

5. (Withdrawn) The method for forming a pattern according to any one of claims 1, 2 and 3, wherein the light-absorbing material is dispersed in the substance to form the substance including the light-absorbing material.

6. (Withdrawn) The method for forming a pattern according to any one of claims 1, 2 and 3, wherein a pigment is used as the light-absorbing material to form the substance including the light-absorbing material.

7. (Withdrawn) The method for forming a pattern according to any one of claims 1, 2 and 3, wherein a photocatalyst substance is used as the light-absorbing material to form the substance including the light-absorbing material.

8. (Previously Presented) The method for forming a pattern according to any one of claims 1, 2 and 3, wherein the wavelength of the light is 300 nm or more and 400 nm or less, and

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the light-absorbing material includes a coumarin.

9. (Withdrawn) The method for forming a pattern according to any one of claims 1, 2 and 3, wherein the substance including the light-absorbing material includes fluorocarbon chains.

10-29. (Canceled)

30. (Previously Presented) The method for forming a pattern according to any one of claims 1, 2 and 3, wherein the wiring is a silver wiring.